Electrical and Structural Properties of CVD-Graphene Oxidized Using KMnO₄/H₂SO₄ Solution

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Abstract: We report the electrical properties of graphene grown via chemical vapor deposition (CVD-graphene) and oxidized using a KMnO₄/dilute H₂SO₄ mixture. CVD-graphene was successfully oxidized without any pores or peeling off from the substrates. When the H₂SO₄ concentration was increased, the electrical resistance of the oxidized graphene (OG) increased. In particular, OG-20 shows a nonlinear current–voltage curve similar to that of a diode owing to direct tunneling through the interfaces between the nanosized sp² and sp³ regions. The changes in electrical properties occurred because of structural evolution. As the H₂SO₄ concentration increased, the number of oxygen functional groups (epoxide/hydroxyl and carboxyl groups) in the OG increased. In addition, a reduction in the average distance between defects in the OG was determined using Raman spectroscopy. Oxidation using a KMnO₄/dilute H₂SO₄ mixture results in CVD-graphene with modified electrical properties for graphene-based applications.

Keywords: graphene; oxidized graphene; oxygen functional groups; potassium permanganate; sulfuric acid

1. Introduction

The chemical functionalization of a graphene surface can easily modify its electrical, chemical, and optical properties. In particular, oxygen functionalization offers metal–insulator transition by controlling the degree of oxidation, reaction sites for the synthesis of other functional groups, and a route for hole doping [1,2]. Thus far, considerable research has been devoted to controlling the metal–insulator transition by manipulating the degree of oxidation through the partial oxidation and reduction of graphene oxide. Jin et al. reported that oxidized graphene (OG) field-effect transistors (FETs) show p-type characteristics for partial oxidation (for 5 min) and insulating behavior for full oxidation (for 60 min) of graphene in air [2]. Goki et al. reported a carrier transport mechanism in partially oxidized graphene (POG) synthesized by varying the reduction time of graphene oxide [3]. They demonstrated that carrier transport in lightly reduced graphene oxide occurs via variable-range hopping, whereas band-like transport dominates in well-reduced graphene oxide. Carrier transport in graphene oxide is intriguing because of the presence of the substantial electronic disorder arising from variable sp² and sp³ carbon ratios. Graphene oxide represents graphene layers with oxygen functional groups decorated on the basal planes and edges. In graphene oxide, most of the carbon atoms bonded with oxygen are sp³ hybridized and disrupt the extended sp² conjugated network of the original graphene sheet. The substantial sp³ fraction in graphene oxide can transform the material into a semiconductor and ultimately to a graphene-like semimetal.

Although a large number of studies have been devoted to the synthesis of graphene oxide via chemical exfoliation using graphite flakes, such as Hummer’s method, there is...
limited availability of mass-production processes for graphene oxide for electronic applications because graphene oxide is a micro-sized sheet [4,5]. Graphene oxide sheets cannot form uniform and large-area films. Graphene grown via chemical vapor deposition (CVD-graphene) has the following advantages: (i) it is easy to achieve the scalable production of graphene suitable for the mass production of graphene-based electronic devices; and (ii) it can form monocrystalline and polycrystalline graphene [6–9]. In addition, it can be patterned using conventional lithography techniques and can be transferred onto flexible substrates with negligible structural damage.

To oxidize the CVD-graphene, many studies have been conducted using dry oxidation methods, such as ozone treatment assisted by UV irradiation and oxygen plasma treatment [10–13]. However, these dry oxidation methods can easily form nanoscale pits (or pores) in the graphene [14–16]. In contrast, wet-based chemical oxidation of CVD-graphene has rarely been reported. The wet oxidation of CVD-graphene offers several advantages, such as a low-cost process, a wide range of solvents that can be used, and easy control of the metal-insulator transition through the adjustment of the oxidation time [2,17].

In this study, we demonstrate the variation in electrical properties and structural evolution of oxidized CVD-graphene using the reagents used in Hummer’s method, which is a mixed solution of KMnO$_4$ and H$_2$SO$_4$. The electrical properties of the oxidized CVD-graphene were evaluated using current–voltage (I-V) plots, as a function of the H$_2$SO$_4$ concentration, and by calculating the Schottky barrier height (SBH, $\Phi_b$) and the gate bias effect. The electrical properties were dependent on the structural properties of OG, which were investigated using scanning electron microscopy (SEM), X-ray photoelectron spectroscopy (XPS), and Raman spectroscopy.

2. Materials and Methods

Graphene layers were grown on Cu foils using a thermal CVD method. The detailed growth procedure was as follows: (1) initial step at 5 mTorr and 1000 °C under 10 sccm of Ar gas for 1 h; (2) annealing at 1000 °C under Ar 10 sccm/H$_2$ 50 sccm atmosphere for 20 min; (3) graphene growth step at 1000 °C under Ar 10 sccm/H$_2$ 50 sccm atmosphere for 20 min; and (4) final step at room temperature (25 °C) under an Ar/H$_2$/CH$_4$ atmosphere. For the transfer of graphene onto SiO$_2$/Si wafers, graphene grown on the other surface of Cu foils was first removed by O$_2$ plasma (SPI supplies, Plasma Prep III) at 100 W for 10 s. Subsequently, the graphene/Cu foil samples were coated with poly methyl methacrylate (PMMA). After the Cu foils were etched in a 0.5 M ammonium persulfate solution, the PMMA/graphene samples were floated on deionized water. Finally, the PMMA/graphene samples were transferred onto SiO$_2$/Si wafers, and the PMMA was removed by immersion in acetone for 1 h.

To measure the electrical properties, the mesa isolation of the graphene sheet with a dimension of $25 \times 50 \mu m^2$ was conducted using O$_2$ plasma treatment. Subsequently, Pd/Au (20 nm/50 nm) metal layers as ohmic contacts and an Au (50 nm) metal pad as an external contact were deposited using an electron-beam evaporator. The distance between the two electrodes was 13 μm. A surface oxidation region with a length of 7 μm was defined using photolithography.

The surface oxidation of graphene was performed using 0.1 g of KMnO$_4$ in a 10–30% dilute H$_2$SO$_4$ mixture. The graphene transferred onto a SiO$_2$/Si wafer was immersed in the KMnO$_4$/dilute H$_2$SO$_4$ mixture for 10 min at 25 °C. Graphene oxidized with different concentrations of H$_2$SO$_4$ is denoted as OG-n, where n represents the H$_2$SO$_4$ concentration. Finally, the graphene on the SiO$_2$/Si wafer was immersed in DI water for 1 min and cleaned by N$_2$ blowing.

Optical microscopy (OM) and field-effect scanning electron microscopy (FE-SEM) were used to characterize the graphene layer transferred onto the SiO$_2$/Si wafer. High resolution transmission electron microscopy (HRTEM) was utilized to investigate the surface of the samples. The chemical bonds of the oxygen functional groups of the samples were investigated using XPS with a Theta Probe AR-XPS system (Thermo Fisher Scientific,
Waltham, MA, USA) with the following parameters: monochromatic Al Kα radiation (hν = 1486.6 eV), X-ray energy of 15 kV, 150 W, and a spot size of 400 µm². Micro Raman spectroscopy (System 1000, Renishaw, Wotton-under-Edge, UK) with a 514 nm diode laser was used to analyze the structural variation of the OG structures. OM objective lenses (×100 magnification) were used to acquire the Raman spectra. The spectral resolution of the equipment is 1800 l/mm gratings. The electrical characteristics of the OG structures were investigated based on DC characteristics using a system combined with HP4156C (Keysight, Santa Rosa, CA, USA) and a probe station.

3. Results and Discussion

Figure 1a presents a schematic of the graphene/OG in-plane heterostructure used to evaluate the electrical properties. OG regions were formed using conventional photolithography. The length of the OG region is 7 µm, as shown in Figure 1b. From the OM image, the OG region has a lighter color than graphene, possibly because of the oxygen functional groups on the OG [18]. The Raman spectra shown in Figure 1c indicate the formation of OG regions after oxidation using KMnO₄/H₂SO₄ solution. The detailed structural changes in the OG are discussed later using XPS and Raman analyses as a function of the H₂SO₄ concentration.

![Figure 1](image)

Figure 1. (a) Schematic and (b) OM image of the graphene/OG heterostructure; and (c) Raman spectra of the graphene and OG-30.

Current–voltage (I-V) curves of graphene/OG-10, OG-20, or OG-30 in-plane heterostructures were obtained. As shown in Figure 2a, b, OG-10 displays a resistance approximately 100 times higher than that of graphene. The I-V plot for OG-20 is a nonlinear curve, which is different from that of OG-10 (Figure 2c). The I-V curve of the graphene/OG-20 structure is similar to that of graphene/graphene oxide vertical contact structures [19]. The OG-30 acts as an insulator, as shown in Figure 2d. Figure 3 shows the I DS-V DS curves as a function of the gate voltage. The OG-20 shows p-type behavior. This is due to the presence of oxygen functional groups on the surface and/or edges of graphene [20].

Assuming an ideal diode without shunt and series resistances, the SBH of the graphene/OG-20 in-plane heterostructure can be calculated by employing a thermionic model, using the following Equation (1):

\[ \Phi_b = \frac{kT}{q} \ln \left( \frac{AT^2A^*}{I_0} \right) \] (1)

where \( k \) is the Boltzmann constant; \( T \) is the absolute temperature; \( q \) is the electronic charge; \( A \) is the contact area of the barrier; \( A^* \) is the Richardson constant (119.7 A·cm⁻²·K⁻² for a free electron); and \( I_0 \) is the saturation current obtained from the I-V curves. The estimated SBH for OG-20 was 0.28 eV.
To demonstrate the change in electrical properties of oxidized CVD-graphene as a function of the H$_2$SO$_4$ concentration, we investigated the structural evolution using XPS and Raman analyses. Figure 4 shows the C1s spectra of graphene, OG-10, OG-20, and OG-30. The graphene (Figure 4b) spectrum indicates the presence of strong C–C bonds, a low amount of epoxide (C–O–C)/hydroxyl (C–OH) groups, and a very small amount of carboxyl groups (O–C=O), at 284.6, 285.4, and 288.7 eV, respectively [21]. In the OG-10 spectrum, the amount of epoxide/hydroxyl and carboxyl groups is slightly higher than that in the graphene. Significantly, the peak intensities corresponding to the oxygen functional groups in OG-20 are significantly higher than those in OG-10 (Figure 4d). In addition, when the H$_2$SO$_4$ concentration was increased further (OG-30), the number of epoxide/hydroxyl groups increased slightly more than that in OG-20. The peak intensity ratio ($I_{OC}/I_{GC}$) of oxidized carbon (285.4, 288.7, and 291 eV) to graphitic carbon (284.6 eV) explains the oxidation degree of graphene oxide [10,22]. The $I_{OC}/I_{GC}$ values of graphene, OG-10, OG-20, and OG-30 were calculated as 0.24, 0.3, 0.6, and 0.84, respectively (see Table 1). Therefore, the increase in the amount of oxygen functional groups changes the shape of the I-V curve from linear (graphene and OG-10) to nonlinear (OG-20).
Figure 4. (a) XPS C 1s spectra of graphene and OG samples as a function of the H$_2$SO$_4$ concentration. Detailed peak analyses of (b) graphene, (c) OG-10, (d) OG-20, and (e) OG-30.

Table 1. Intensity ratio of the oxidized carbon and graphitic carbon (I$_{OC}$/I$_{GC}$) as a function of the H$_2$SO$_4$ concentration.

<table>
<thead>
<tr>
<th>Chemical Bonds</th>
<th>Graphene</th>
<th>OG-10</th>
<th>OG-20</th>
<th>OG-30</th>
</tr>
</thead>
<tbody>
<tr>
<td>Graphitic carbon (%)</td>
<td>80.38</td>
<td>77.06</td>
<td>62.59</td>
<td>54.33</td>
</tr>
<tr>
<td>Oxidized carbon (%)</td>
<td>19.62</td>
<td>22.94</td>
<td>37.41</td>
<td>45.67</td>
</tr>
<tr>
<td>I$<em>{OC}$/I$</em>{GC}$</td>
<td>0.24</td>
<td>0.30</td>
<td>0.60</td>
<td>0.84</td>
</tr>
</tbody>
</table>

Figure 5a shows the Raman spectra of graphene, OG-10, OG-20, and OG-30. The graphene spectrum shows sharp G- and 2D-bands at 1587.5 and 2688.9 cm$^{-1}$, with full width at half maximum (FWHM) values of 17.8 and 33.9 cm$^{-1}$, respectively, whereas a negligible D-band is observed at approximately 1340 cm$^{-1}$. In the OG-10 spectrum, D- and D’-bands (1625 cm$^{-1}$), which are associated with defects in graphene, appear, and the 2D-band intensity is slightly decreased compared to that of the graphene [23,24]. The defects in the OG-10 are due to vacancies, physical adsorption of oxygen-related molecules, and oxygen functional groups, including epoxide/hydroxyl, carbonyl, and carboxyl groups [22]. Compared with the OG-10, the FWHM of the G-band of OG-20 increases from 29.6 cm$^{-1}$ (OG-10) to 63.4 cm$^{-1}$ (OG-20) as shown in Figure 5b. Moreover, the 2D-band intensity is significantly reduced in OG-20.

The average distance between defects (L$_D$) in the OG can be calculated approximately using the intensity ratio of D- to G-bands (I$_D$/I$_G$) [25,26]. Ferrari and co-workers proposed a three-stage classification of the disorder of graphitic materials from graphite to amorphous carbon using Raman spectroscopy [24,27]. The first is from graphite to nanocrystalline graphite; the second is from nanocrystalline graphite to low sp$^2$ amorphous carbon, and the third is from low sp$^2$ amorphous carbon to high sp$^2$ amorphous carbon. To calculate the L$_D$ of the graphene and OG specimens, we considered the following results of previous studies [28]. First, from graphene to graphene oxide, the I$_D$/I$_G$ values initially increased (stage 1) and then decreased (stage 2). Second, the OG in stages 1 and 2 can have similar I$_D$/I$_G$ values, while the L$_D$ decreases. Finally, the FWHM of the G-band increases with an increase in defects; therefore, the I$_D$/I$_C$ value and FWHM of the G-band must be considered simultaneously because of much larger values in stage 2. Figure 5c plots I$_D$/I$_C$ versus the H$_2$SO$_4$ concentration (0% H$_2$SO$_4$ indicates graphene). The I$_D$/I$_C$ values of OG specimens changed from 0.04 for graphene to 0.843 for OG-10, 1.06 for OG-20, and 0.878 for OG-30. Therefore, the I$_D$/I$_C$ value increases from graphene to OG-20, but the
value for OG-30 is similar to that of OG-10. In addition, the G-band FWHM of OG-20 was significantly higher than that of OG-10. Considering the above results, graphene and OG-10 are stage 1 graphitic materials, and OG-20 and OG-30 are stage 2 materials. The \( L_D \) values of graphene and OG specimens were calculated to be 49.28 (graphene), 11.04 (OG-10), 1.387 (OG-20), and 1.263 nm (OG-30), as shown in Figure 5d. These results indicate that the change in the electrical properties is due to the formation of oxygen functional groups, leading to the structural disorder.

![Diagram](image-url)

**Figure 5.** (a) Raman spectra, (b) G-band FWHM, (c) \( I_D/I_G \), and (d) average distance between defects (\( L_D \)) of graphene and OGs as a function of the \( \text{H}_2\text{SO}_4 \) concentration.

The phenomenon of carrier transport in the graphene/OG-20 in-plane heterostructure can be explained using the Mott variable-range hopping (VRH) model, which involves consecutive inelastic tunneling processes between localized states [29–32]. Perhaps, OG-20 is composed of nano-sized sp\(^2\) domains and a sp\(^3\) matrix (disordered region), which is confirmed by the calculated \( L_D \) values as shown in Figure 5, and the disordered region plays a role as a transport barrier at the interface [32]. As shown in Figure 6, the FE-SEM image of OG-20 shows some heterogeneity in contrast, whereas the graphene appears relatively uniform. This is because of the difference in the electrical resistance between the graphene and OG-20 regions [10]. Moreover, HRTEM images (Figure 7) present the different surface morphologies of graphene and OG-20. The OG-20 has a smaller grain size than that of the graphene. The results verify the increase in the disordered regions in OG-20. The oxygen functional groups form discontinuous localized states below the conduction band, which play an important role in trapping the electrical carriers and scattering during transport. The direct tunneling of carriers through the interface between the sp\(^2\) and sp\(^3\) domains reveals a nonlinear I-V curve in OG-20. Therefore, it is confirmed that the electrical properties of the graphene/OG-20 in-plane heterostructures changed to a nonlinear curve with an SBH of 0.28 eV, owing to the many structural variations created by the oxygen functional groups in OG-20.
4. Conclusions

In summary, we demonstrated variations in the electrical properties of CVD-graphene oxidized using different amounts of KMnO$_4$/H$_2$SO$_4$. The degree of oxidation of the OG specimens can be simply controlled by varying the H$_2$SO$_4$ concentration. When the H$_2$SO$_4$ concentration is above 20%, the graphene/OG in-plane heterostructure exhibits a nonlinear curve. The SBH of OG-20 was calculated to be 0.28 eV. Charge carrier transport in our devices was due to direct tunneling through interfaces between nanosized sp$^2$ and sp$^3$ regions. The sp$^3$ regions are formed by oxygen functional groups on the graphene surface. As a result, our simple oxidation technique enabled the modification of the electrical properties of CVD-graphene. Furthermore, the electrical characteristics of the graphene/OG in-plane heterostructures allow the design of functionalized graphene-based applications with in-plane heterostructures.

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